



A Modular Approach to Acquisition Systems for Future CERN Beam Instrumentation Developments

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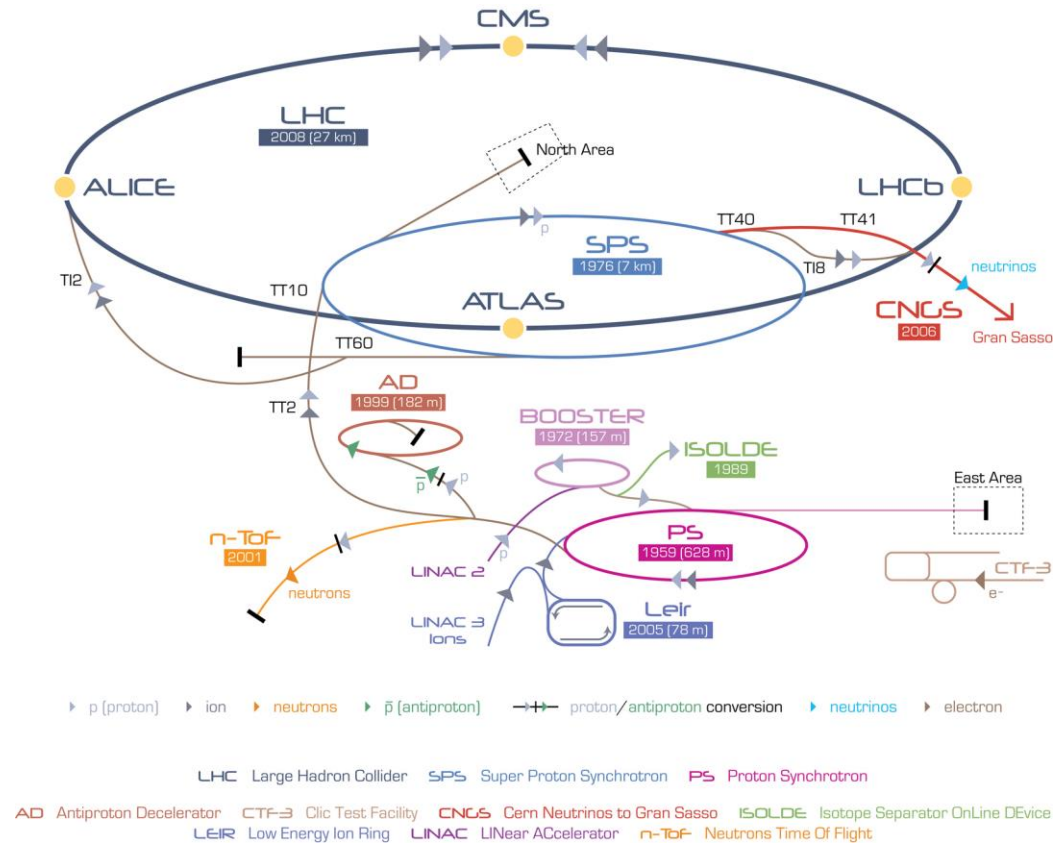
CERN BE-BI

BE-BI: what do we do?

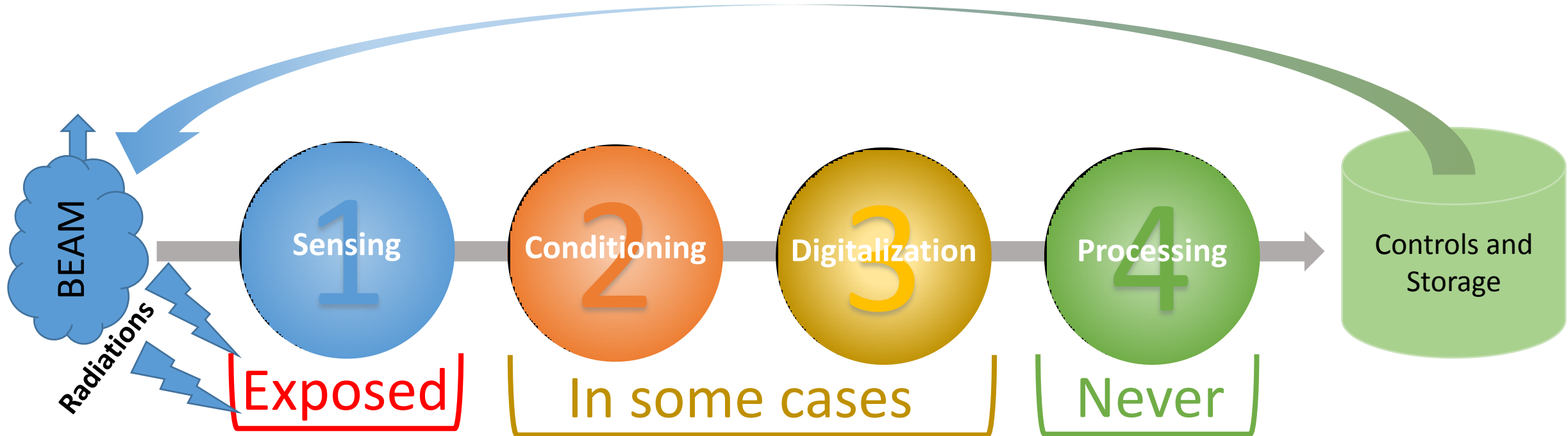
Design and maintenance of :

- Beam loss monitors
- Beam position monitors
- Tune measurement systems
- Beam intensity
- Longitudinal and transverse profiles
-

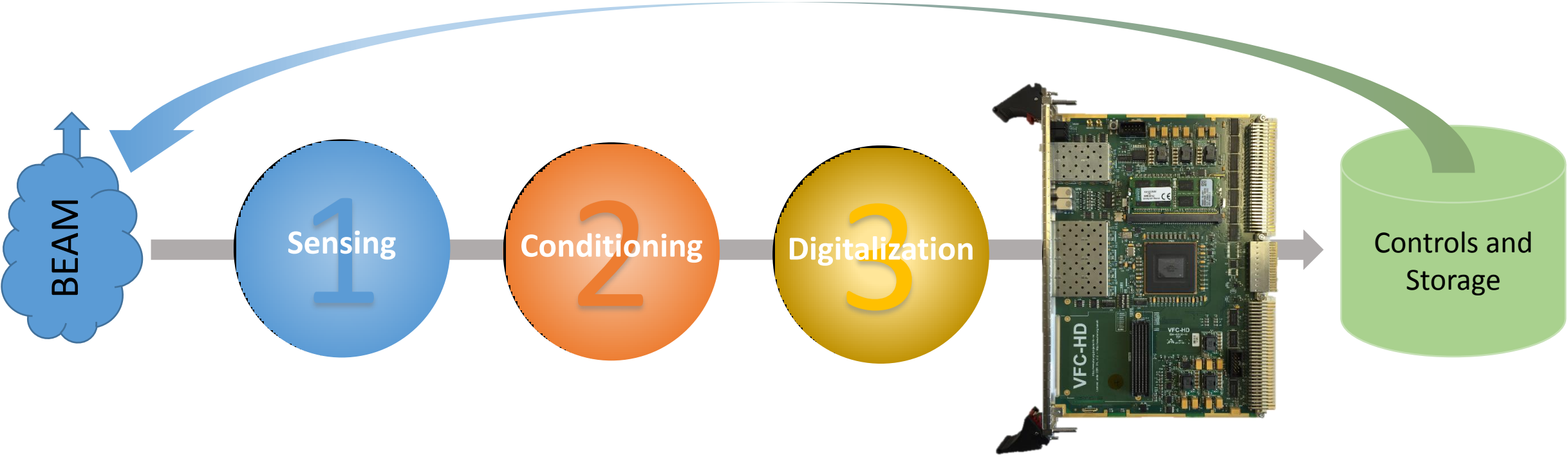
For all the CERN accelerator complex



BE-BI: what do we do?



First step of standardization/modularization



The VME FMC Carrier - HPC mezzanine and DDR3 memories : VFC-HD

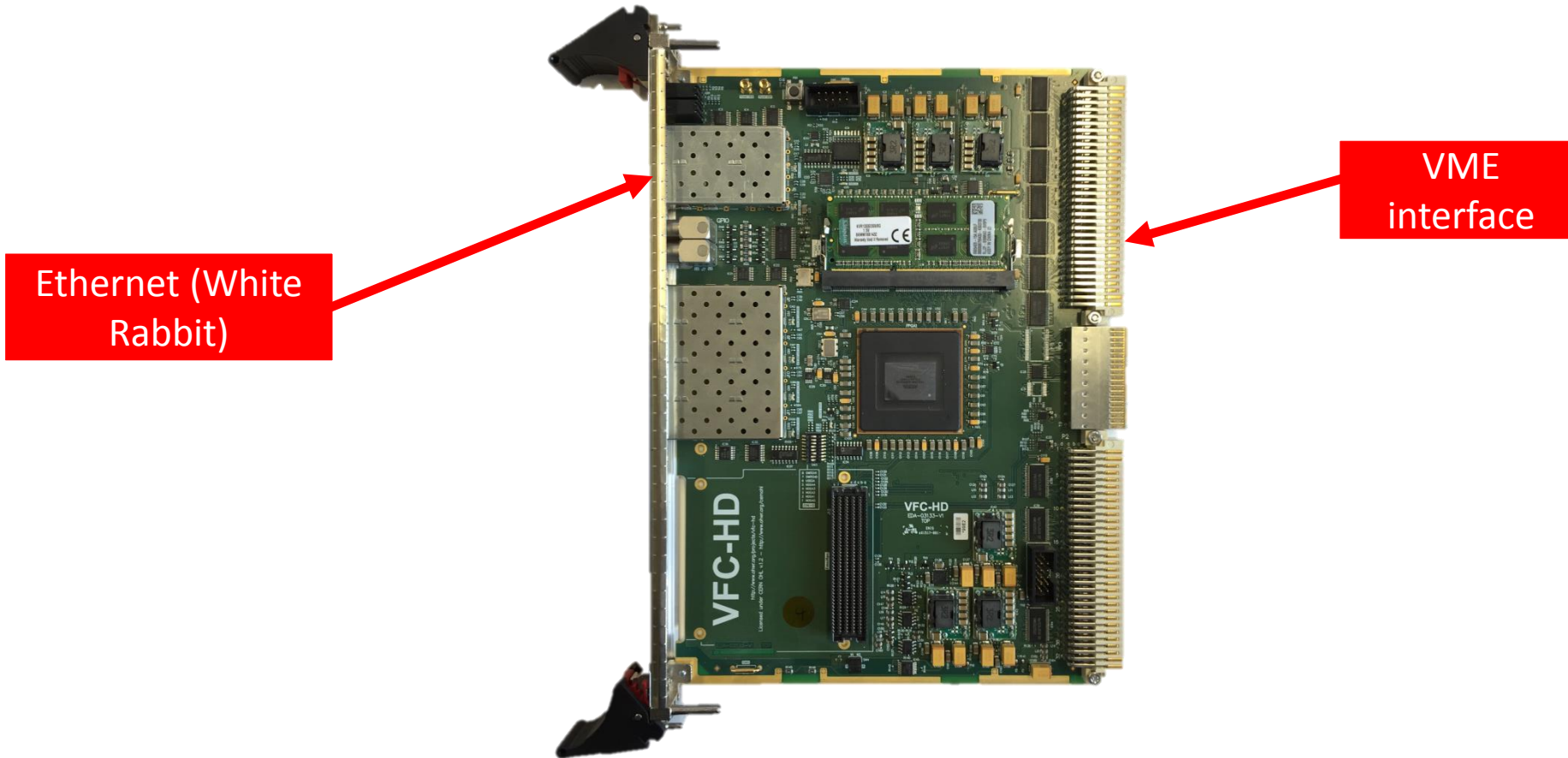


Processing Support

Interfacing elements

Modularity

The VME FMC Carrier - HPC mezzanine and DDR3 memories : VFC-HD

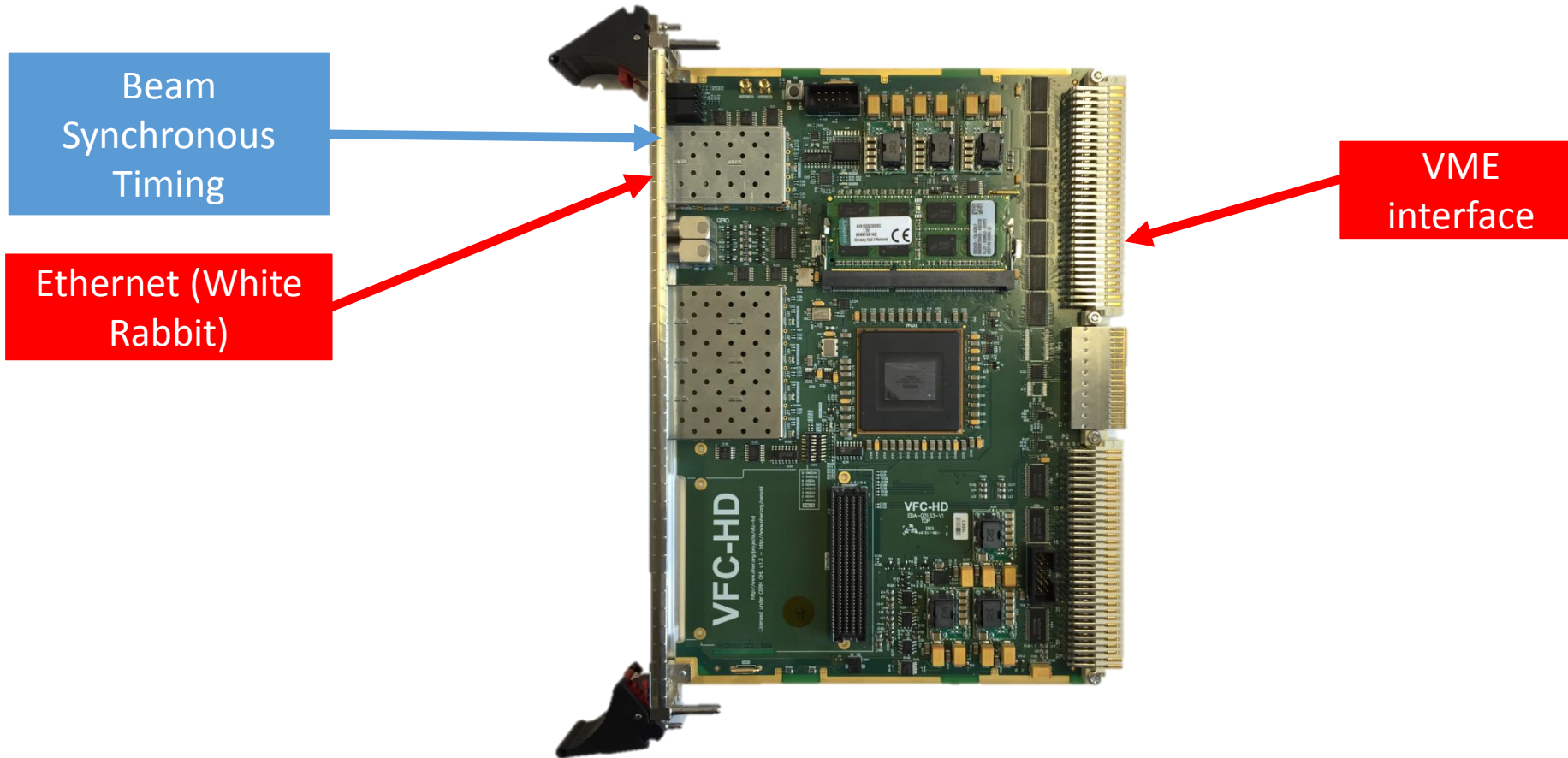


Processing Support

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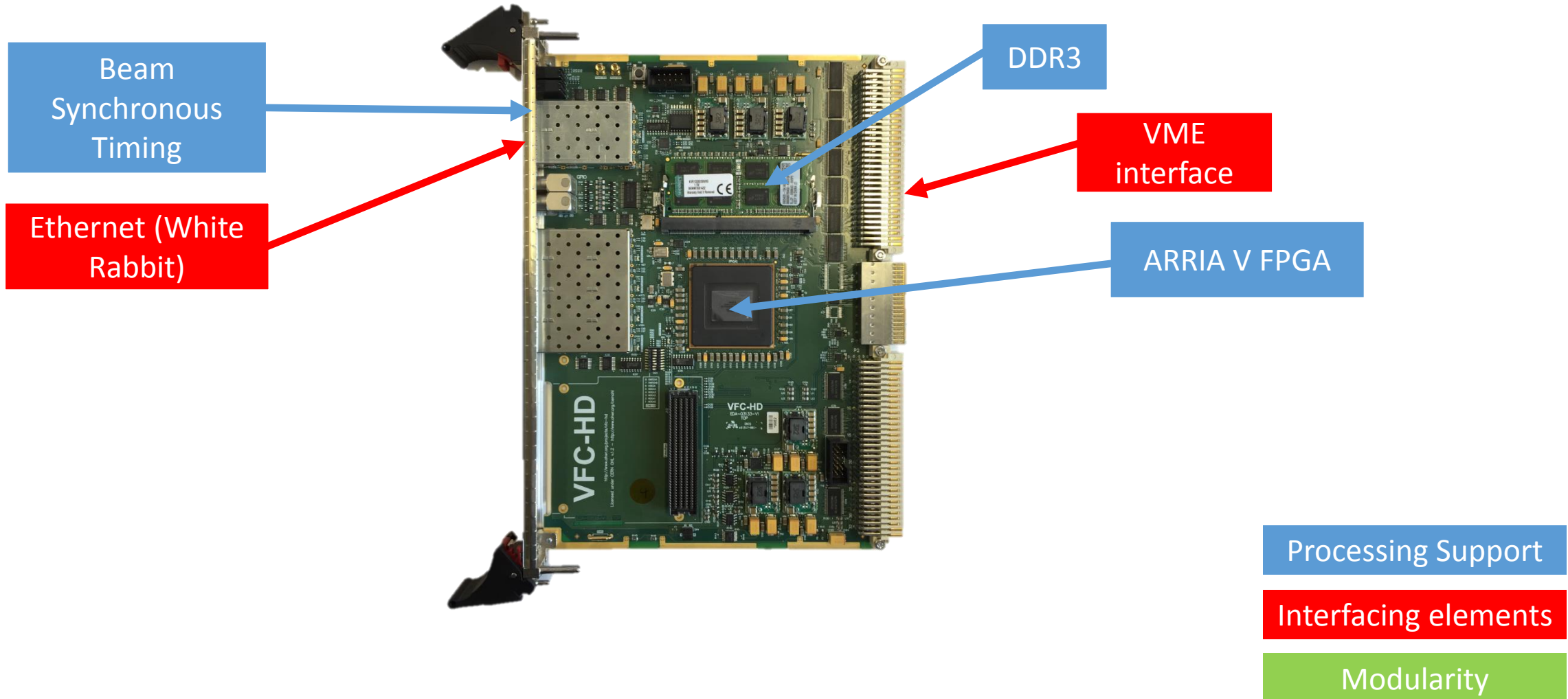
Modularity

The VME FMC Carrier - HPC mezzanine and DDR3 memories : VFC-HD

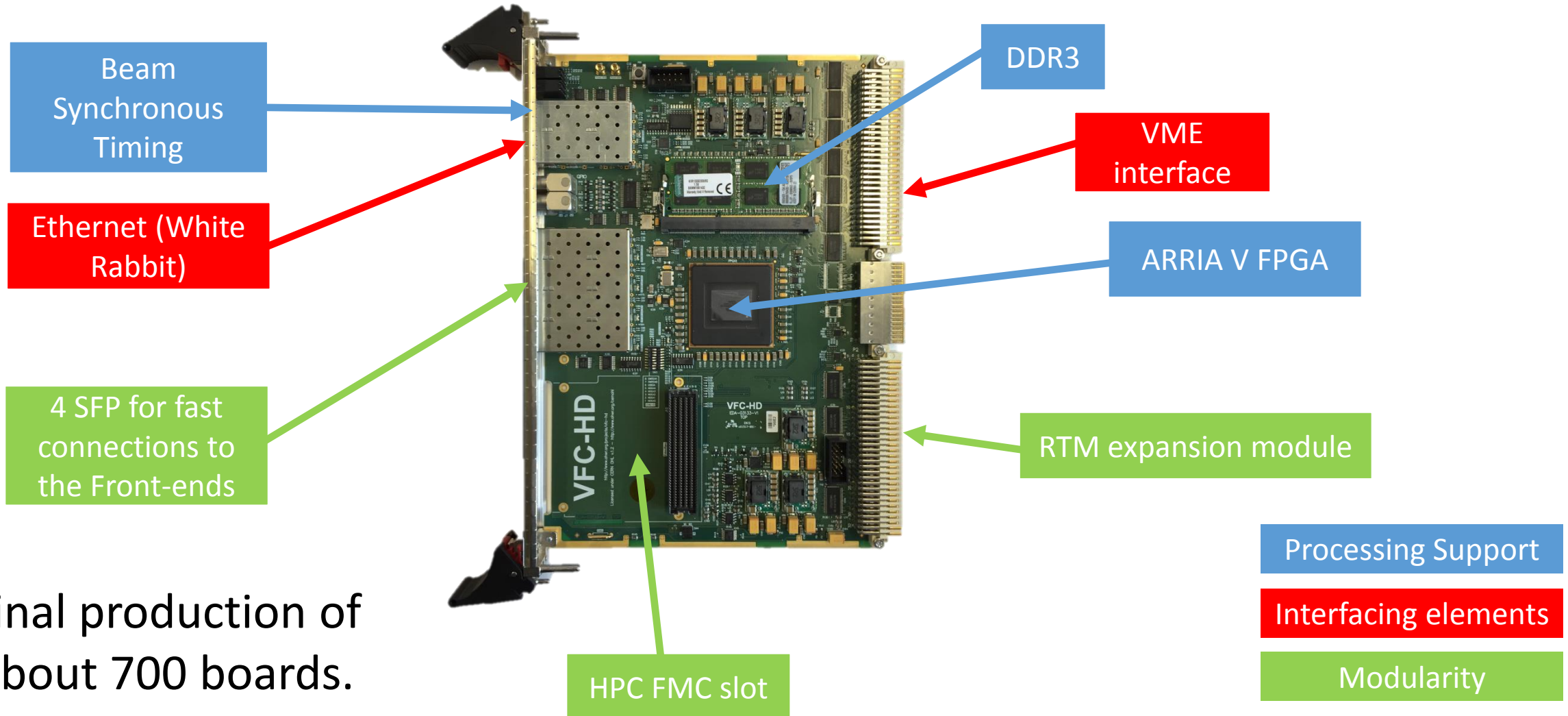


- Processing Support
- Interfacing elements
- Modularity

The VME FMC Carrier - HPC mezzanine and DDR3 memories : VFC-HD



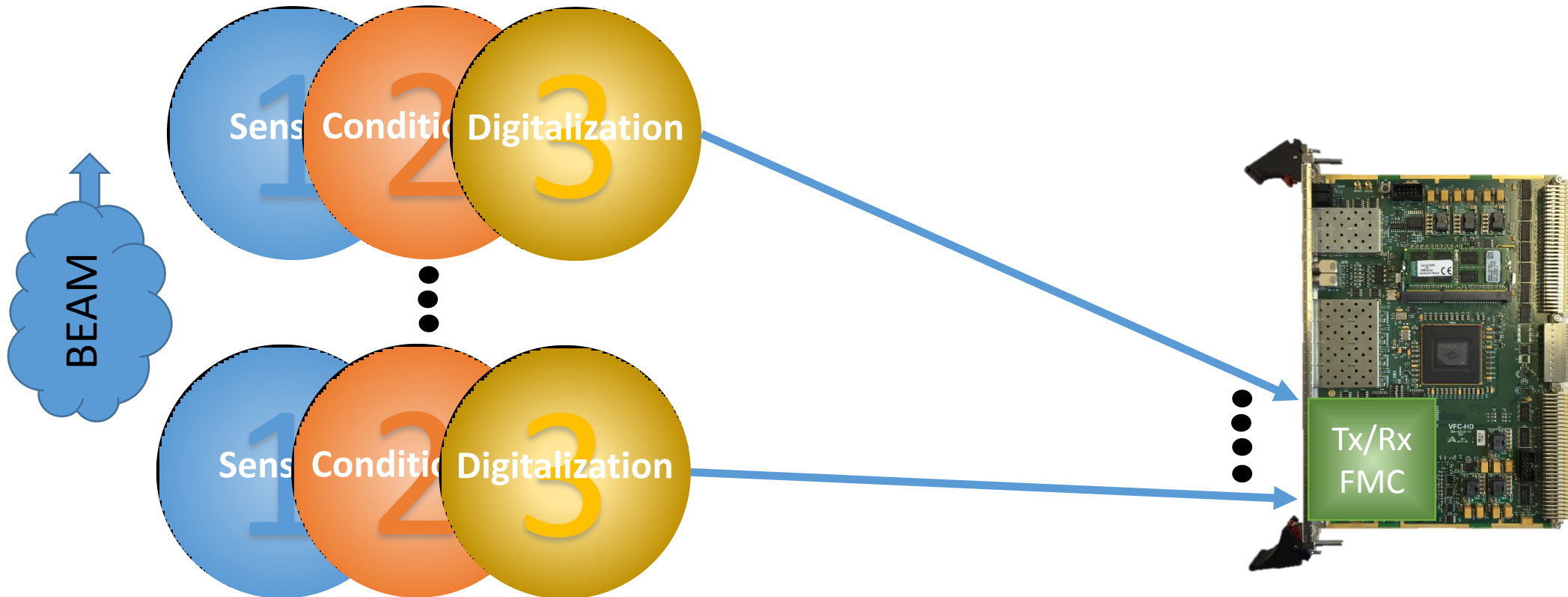
The VME FMC Carrier - HPC mezzanine and DDR3 memories : VFC-HD



Final production of about 700 boards.

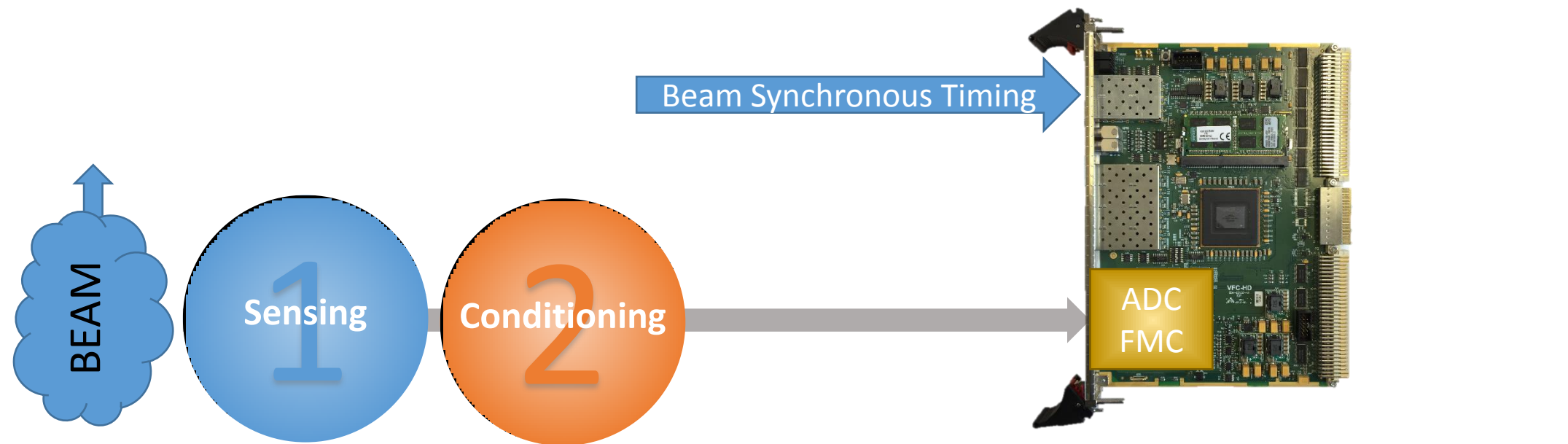
Slow sampling systems examples

- DC current transformers
- AWAKE BPMs

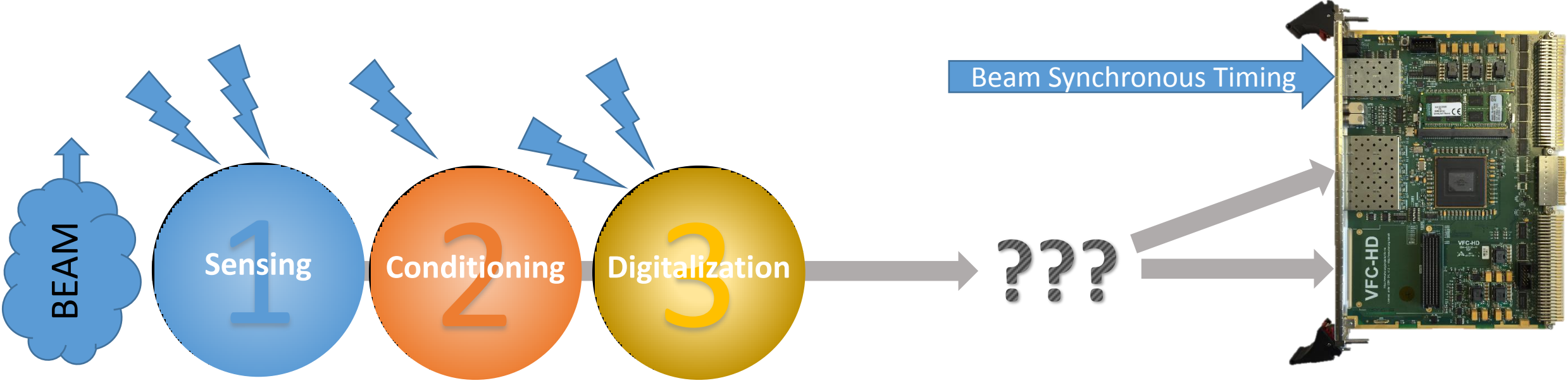


Fast sampling systems examples

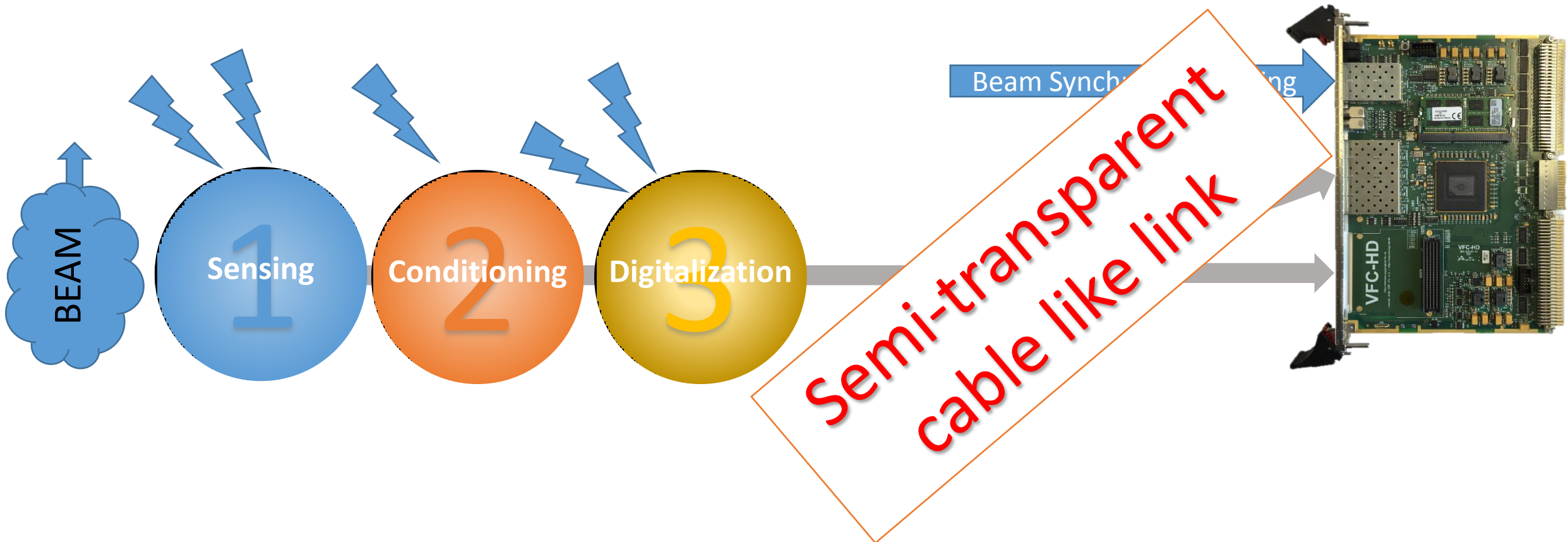
- Fast Beam Current Transformers
- Diamond BLM



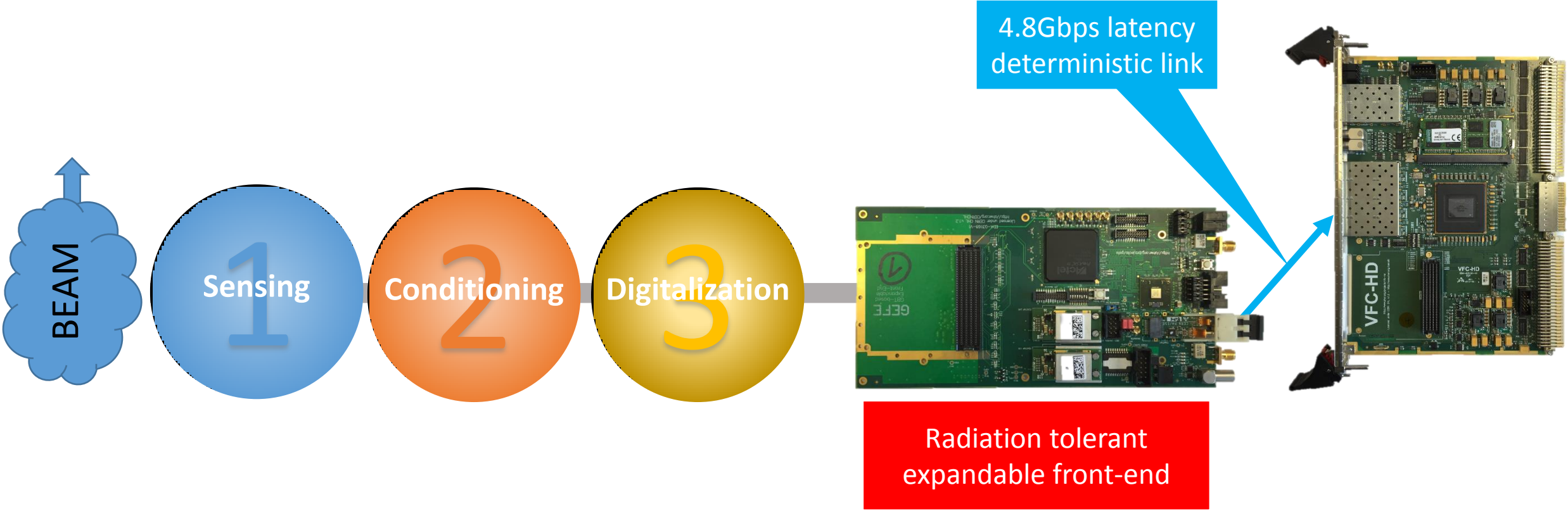
Fast sampling systems.... What if we need to digitize close to the beam?



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The GBT Expansible Front-End: GEFE



Glue logic

Interfacing elements

Modularity

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Radiation hard 4.8Gbps
latency deterministic
bidirectional link

ProAsic 3 FPGA

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HPC-FMC slot*
*DP lines not complying with the standard

ProAsic 3 FPGA

Radiation hard 4.8Gbps
latency deterministic
bidirectional link

Glue logic

Interfacing elements

Modularity

The GBT Expansible Front-End: GEFE



Target total ionising dose
target: 75 krad

HPC-FMC slot*
*DP lines not complying
with the standard

ProASIC 3 FPGA

Radiation hard 4.8Gbps
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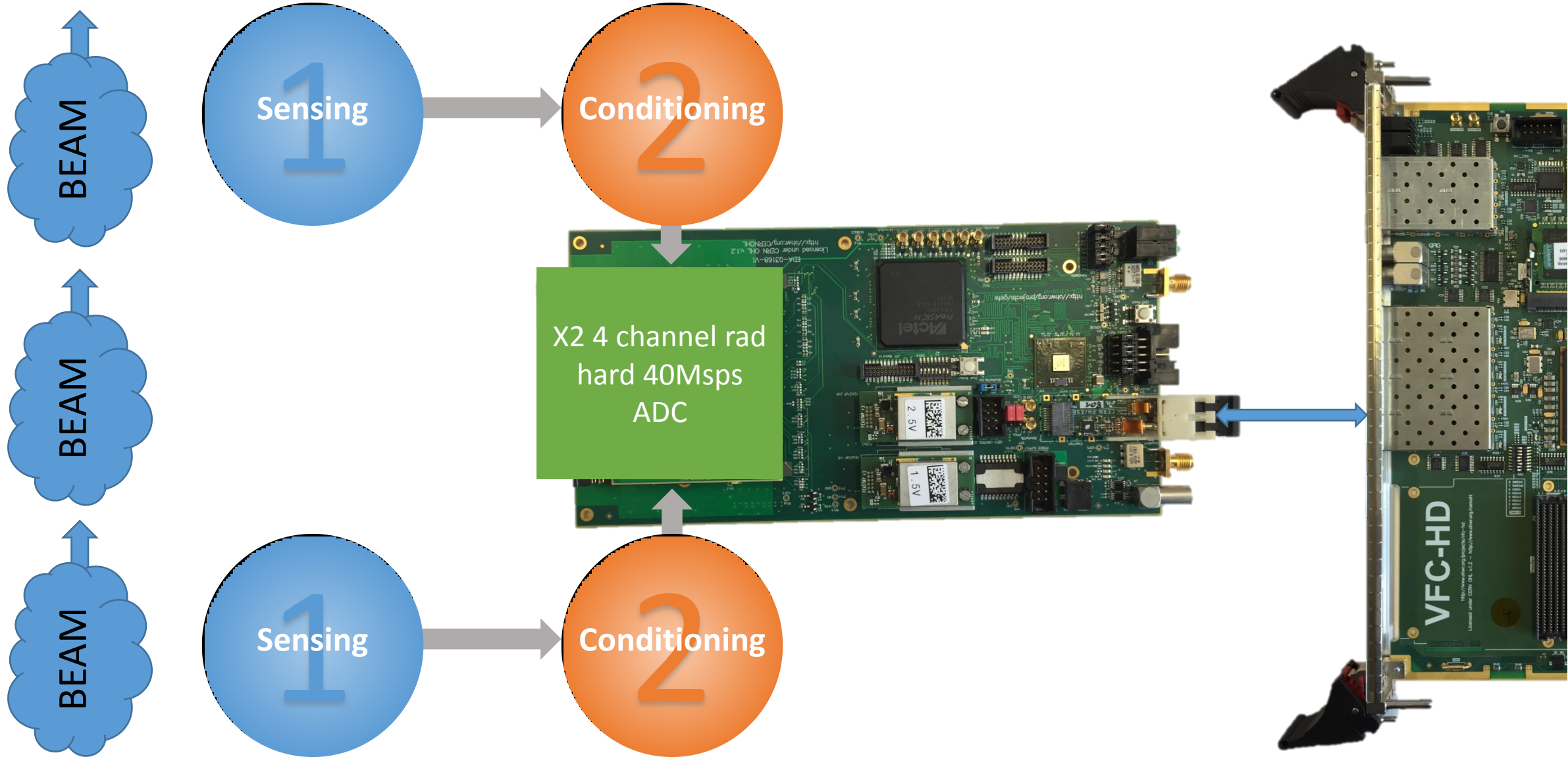
Glue logic

Interfacing elements

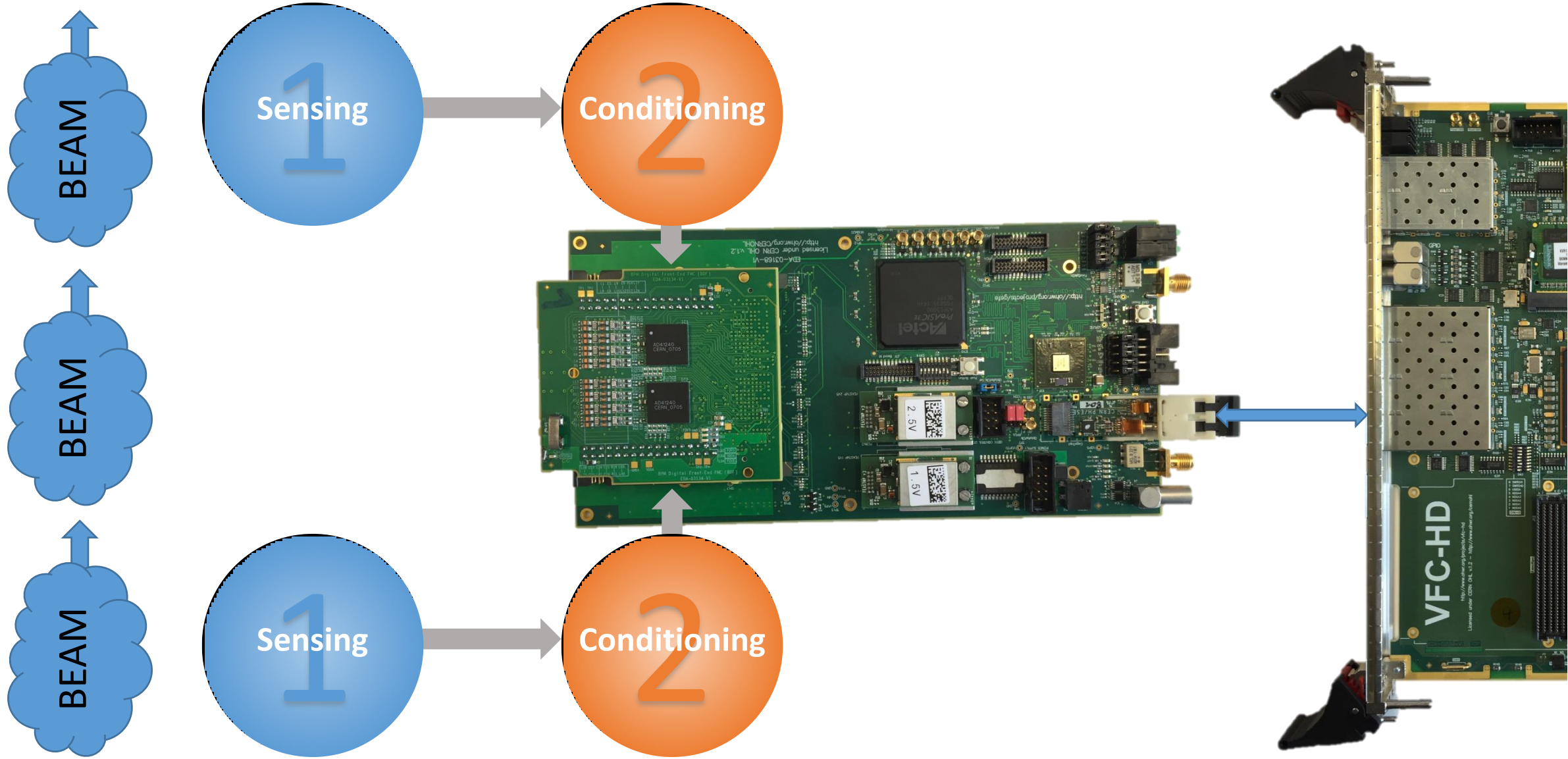
Modularity

Final production of
about 500 boards.

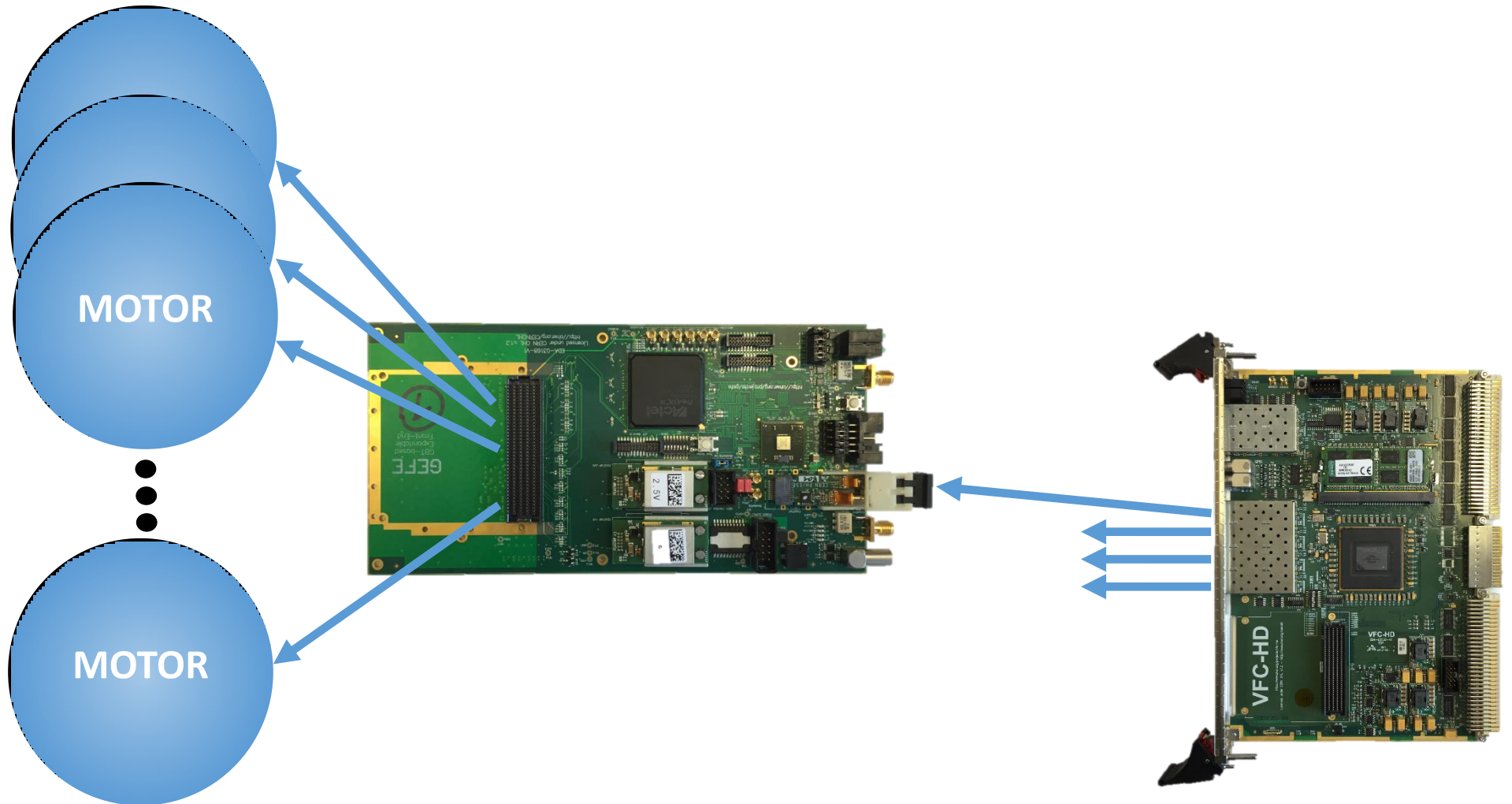
The new SPS BPM system example



The new SPS BPM system example



Not only instruments... the motor controller



Conclusions and lesson learned

- BE BI is going toward a modular approach for its DAQs
- The basic modules of future instruments will be:
 - A VME and Ethernet based FMC carrier
 - A Multi Gbit latency deterministic optical link
 - A radiation tolerant Front-End
- The development of the 2 boards had really different history:
 - The VFC (back-end) was since the beginning thought as general purpose module and went through 3 major redesign and specification changes
 - The GEFE was developed at the beginning for a specific instrument and later adopted by others



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Thank you for the attention 😊

